

#### Description

The IRF7807ZPBF uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

V<sub>DS</sub> = 30V I<sub>D</sub> =8.5A

 $R_{DS(ON)}$  < 18m $\Omega$  @ V<sub>GS</sub>=10V

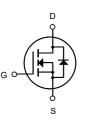
### Application

Battery protection

Load switch Uninterruptible power supply



SOP-8



N-Channel MOSFET

### Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
IRF7807ZPBF	SOP-8	HXY MOSFET	3000

## Absolute Maximum Ratings (T\_A = 25 $^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	30	V
Vgs	Gate-Source Voltage	Gate-Source Voltage ±20	
I <sub>D</sub> @T <sub>A</sub> =25°C	Continuous Drain Current <sup>1</sup>	ntinuous Drain Current <sup>1</sup> 8.5	
I <sub>D</sub> @T <sub>A</sub> =70°C	Continuous Drain Current <sup>1</sup>	Continuous Drain Current <sup>1</sup> 5.6	
Ідм	Pulsed Drain Current <sup>2</sup>	Pulsed Drain Current <sup>2</sup> 35	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	ergy <sup>3</sup> 20	
las	Avalanche Current	anche Current 20	
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation <sup>4</sup>	1.5	W
Тятд	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R <sub>eja</sub>	Thermal Resistance Junction-ambient¹(t≤10s)	85	°C/W
	Thermal Resistance Junction-ambient <sup>1</sup>	25	°C/W

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V	
$\triangle BV_{\text{DSS}} / \triangle T_{\text{J}}$	BVDSS Temperature Coefficient	Reference to 25°C,I₀=1mA		0.034		V/°C	
R <sub>DS(ON)</sub>	Statia Drain Source On Begistenes <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =7A		14	18	mΩ	
	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =4A		20	26		
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.2	1.5	2.5	V	
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	──V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-3.84		mV/°C	
l	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	- uA	
IDSS		V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5		
lgss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =7A		6.2		S	
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.04	2.1	Ω	
Qg	Total Gate Charge (4.5V)			6	8.4		
$Q_gs$	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =7A		2.2	3.1	nC	
Q <sub>gd</sub>	Gate-Drain Charge			2	2.8		
T <sub>d(on)</sub>	Turn-On Delay Time			1.2	2.4		
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_G$ =3.3 $\Omega$		40	72.0	ns	
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =7A		18	36.0		
T <sub>f</sub>	Fall Time			7.2	14.4		
Ciss	Input Capacitance			583	816.2		
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		77	107.8	pF	
Crss	Reverse Transfer Capacitance			59	82.6		
ls	Continuous Source Current <sup>1,5</sup>				7	А	
Ism	Pulsed Source Current <sup>2,5</sup>	──V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			35	А	
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V	
trr	Reverse Recovery Time			7.2		nS	
Qrr	Reverse Recovery Charge	I⊧=7A , dl/dt=100A/µs , Tյ=25°C		2.9		nC	

## Electrical Characteristics (TJ=25 °C, unless otherwise noted)

Note :

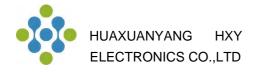
1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH, I<sub>AS</sub>=20A

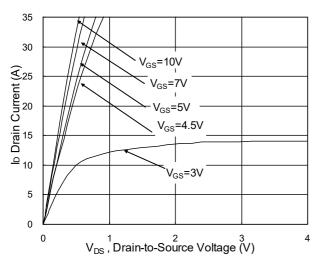
4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# IRF7807ZPBF N-Channel Enhancement Mode MOSFET

### **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

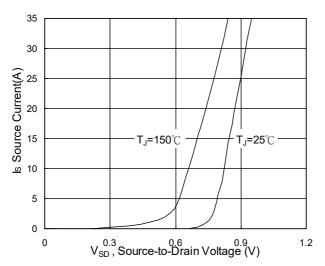


Fig.3 Forward Characteristics Of Reverse

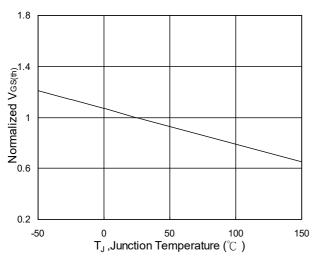


Fig.5 Normalized  $V_{\text{GS}(\text{th})}$  vs.  $T_{\text{J}}$ 

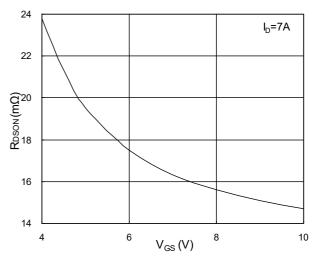


Fig.2 On-Resistance vs. Gate-Source

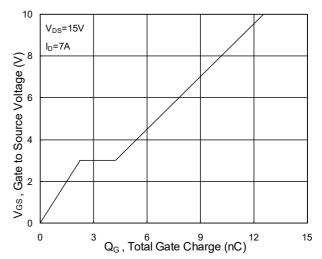


Fig.4 Gate-Charge Characteristics

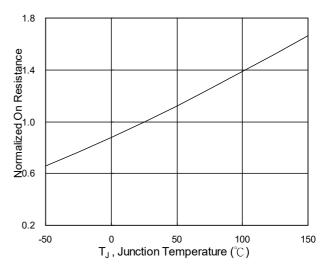


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>



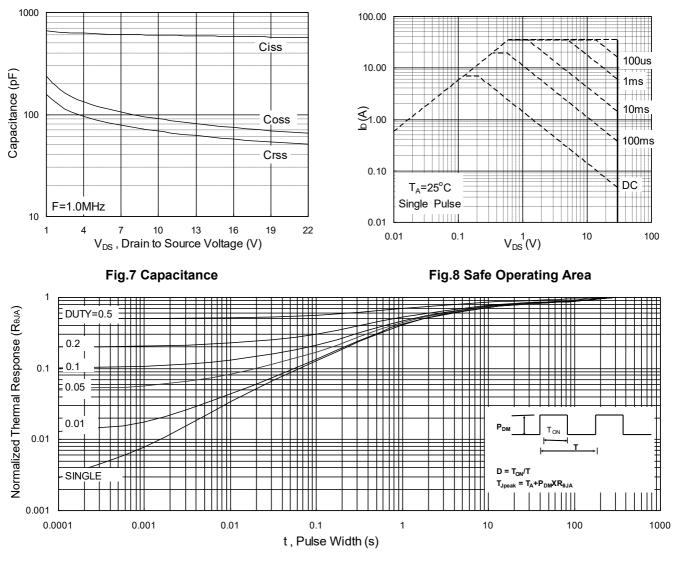


Fig.9 Normalized Maximum Transient Thermal Impedance

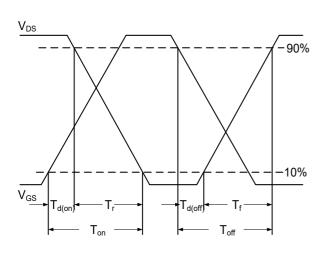


Fig.10 Switching Time Waveform

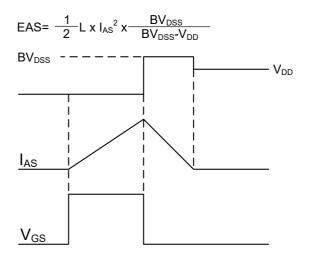
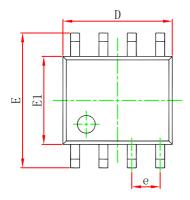
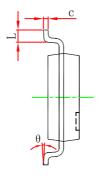


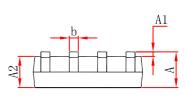
Fig.11 Unclamped Inductive Switching Waveform



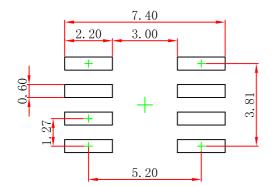
## SOP-8 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0 °	8°	0 °	8°	



Note: 1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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